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P/1250-272

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Tadashi MAEGAWA, et al.

Date: June 22, 2004

Serial No.: 10/789,870

Group Art Unit: 2812

Filed: February 26, 2004

Examiner:

For: SUBSTRATE PROCESSING APPARATUS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUBMISSION

Sir:

Submitted herewith is a copy of art together with a form listing the same for the convenience of the Examiner.

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Max Moskowitz

Name of applicant, assignee or
Registered Representative

Signature

June 22, 2004

Date of Signature

Respectfully submitted,

Max Moskowitz

Registration No.: 30,576

OSTROLENK, FABER, GERB & SOFFEN, LLP

1180 Avenue of the Americas

New York, New York 10036-8403

Telephone: (212) 382-0700

APPLICANT'S ART CITATION (Use several sheets if necessary)		Application 10/789,870		OFGS File No. P/1250-272	
		Applicant Tadashi MAEGAWA et al			
		Filing Date February 26, 2004		Group Art Unit 2812	

NOTED
 JUN 25 2004
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U.S. PATENT DOCUMENTS						
Examiner Initial	Document Number	Date MM-YYYY	Name	Class	Sub-class	Filing Date If Appropriate
	US-					
	US-					
	US-					
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FOREIGN PATENT DOCUMENTS							
	Document Number	Date MM-YYYY	Country	Class	Sub-class	Translation	
						Yes	No
	11-268827	10-1999	Japan			Description only	
	11-274271	10-1999	Japan			Description only	
	11-260-886	9-1999	Japan			Abstract only	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)		

Examiner	Date Considered
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